

## STGB10NC60K

# 10 A, 600 V short-circuit rugged IGBT

#### **Features**

- Low on voltage drop (V<sub>CESAT</sub>)
- Short-circuit withstand time 10 µs

## **Applications**

- High frequency motor controls
- SMPS and PFC in both hard switch and resonant topologies
- Motor drives

### **Description**

This device utilizes the advanced Power MESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

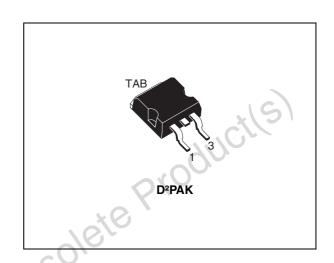


Figure 1. Internal schematic diagram

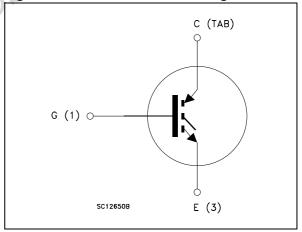


Table 1. Device summary

Part number	Marking	Package	Packaging	
STGB10NC60KT4	GB10NC60K	D <sup>2</sup> PAK	Tape and reel	

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Electrical ratings STGB10NC60K

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GE</sub> = 0)	600	V
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 25°C	20	Α
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 100°C	10	Α
I <sub>CL</sub> (2)	Turn-off latching current	30	Α
I <sub>CP</sub> (3)	Pulsed collector current	30	Α
V <sub>GE</sub>	Gate-emitter voltage	±20	V
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	65	W
T <sub>STG</sub>	Storage temperature	- 55 to 150	လ
TJ	Operating junction temperature	- 55 10 150	O
t <sub>SCW</sub>	Short-circuit withstand time ( $V_{CE} = 0.5 V_{CES}$ , $T_{J} = 125  ^{\circ}C$ , $R_{G} = 10  \Omega$ , $V_{GE} = 12  V$ )	10	μs

<sup>1.</sup> Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2.  $V_{clamp}$  = 80 %  $V_{CES}$ ,  $V_{GE}$  = 15 V,  $R_{G}$  = 10  $\Omega$ ,  $T_{J}$  = 150 °C
- 3. Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance junction-case	1.9	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient	62.5	°C/W

# 2 Electrical characteristics

 $T_J = 25$  °C unless otherwise specified.

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage (V <sub>GE</sub> = 0)	I <sub>C</sub> = 1mA	600			V
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	v <sub>GE</sub> = 15V, I <sub>C</sub> = 5A V <sub>GE</sub> = 15V, I <sub>C</sub> = 5A, T <sub>J</sub> =125°C		2.2 1.8	2.5	< <
V <sub>GE(th)</sub>	Gate threshold voltage	V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250 μA	4.5		6.5	٧
I <sub>CES</sub>	Collector cut-off current (V <sub>GE</sub> = 0)	V <sub>CE</sub> = 600 V V <sub>CE</sub> = 600 V, T <sub>J</sub> = 125 °C		1110	150 1	μA mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ± 20 V	10/	),	±100	nA
9 <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	V <sub>CE</sub> = 15 V <sub>,</sub> I <sub>C</sub> = 5A		15		S

<sup>1.</sup> Pulse test: pulse duration < 300  $\mu$ s, duty cycle < 2 %.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25V$ , $f = 1MHz$ , $V_{GE} = 0$		380 46 8.5		pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE}$ = 390V, $I_{C}$ = 5A, $V_{GE}$ = 15V, (see Figure 17)		19 5 9		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC}$ = 390V, $I_{C}$ = 5A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15V, (see Figure 18)		17 6 655		ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC}$ = 390V, $I_{C}$ = 5A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15V, Tj=125°C (see Figure 18)		16.5 6.5 575		ns ns A/µs
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	$V_{cc} = 390V, I_C = 5A,$ $R_{GE} = 10\Omega, V_{GE} = 15V,$ (see Figure 18)		33 72 82		ns ns ns
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	$V_{cc}$ = 390V, $I_{C}$ = 5A, $R_{GE}$ =10 $\Omega$ , $V_{GE}$ =15V, Tj=125°C (see Figure 18)		60 106 136		ns ns ns

Electrical characteristics STGB10NC60K

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC}$ = 390V, $I_{C}$ = 5A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ =15V, (see Figure 18)		55 85 140		μJ μJ μJ
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup>	Turn-on switching losses Turn-off switching losses	$V_{CC} = 390V, I_{C} = 5A$ $R_{G} = 10\Omega, V_{GE} = 15V,$ $T_{I} = 125^{\circ}C$		87 162		μ <b>J</b> μ <b>J</b>

Table 7. Switching energy (inductive load)

(see Figure 18)

## 2.1 Electrical characteristics (curves)

Total switching losses

Figure 2. Output characteristics

 $\mathsf{E}_{\mathsf{ts}}$ 

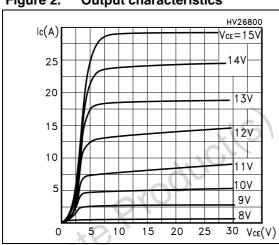
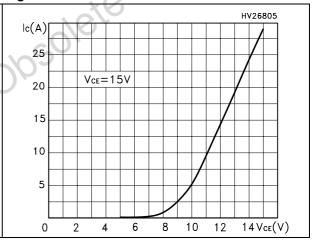


Figure 3. Transfer characteristics

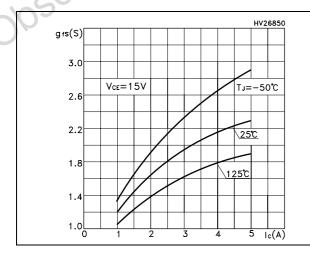


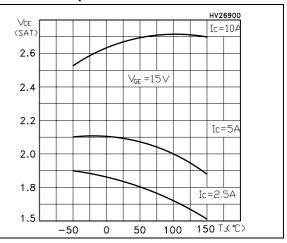
249

μJ

Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature



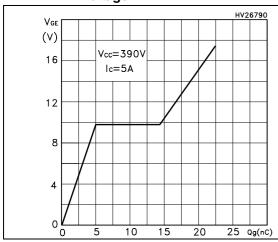


Eon is the tun-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a
package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same
temperature (25°C and 125°C)

<sup>2.</sup> Turn-off losses include also the tail of the collector current

Figure 6. Gate charge vs. gate-source voltage

Figure 7. Capacitance variations



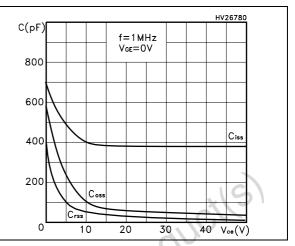
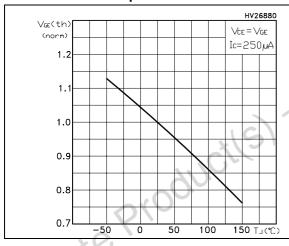


Figure 8. Normalized gate threshold voltage Figure 9. vs. temperature

igure 9. Collector-emitter on voltage vs collector current



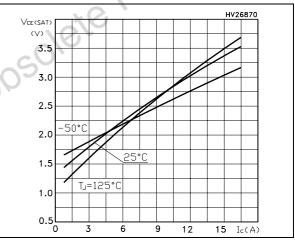
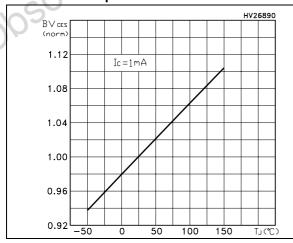
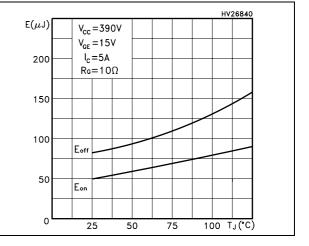


Figure 10. Normalized breakdown voltage vs temperature

Figure 11. Switching losses vs temperature

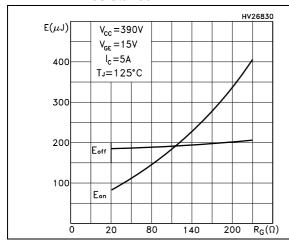




Electrical characteristics STGB10NC60K

Figure 12. Switching losses vs. gate resistance

Figure 13. Switching losses vs collector current



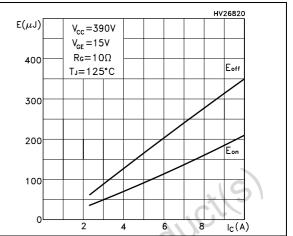
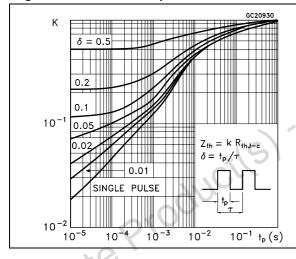
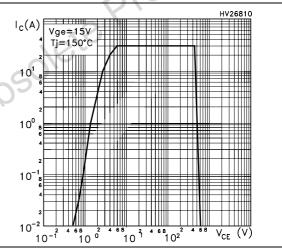


Figure 14. Thermal impedance

Figure 15. Turn-off SOA





STGB10NC60K Test circuits

# 3 Test circuits

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

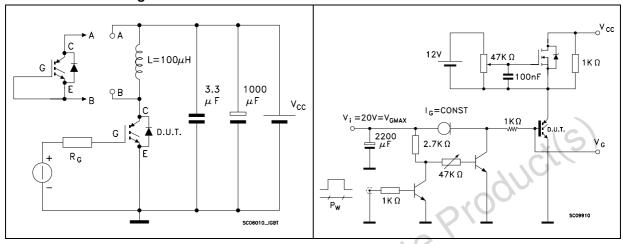
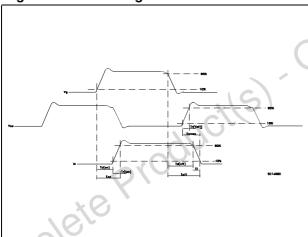


Figure 18. Switching waveform



# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 8. D2PAK (TO-263) mechanical data

D:		mm		
Dim.	Min.	Тур.	Max.	
Α	4.40		4.60	
A1	0.03		0.23	
b	0.70		0.93	
b2	1.14	Y	1.70	
С	0.45	9/2	0.60	
c2	1.23	7/8,	1.36	
D	8.95	10S	9.35	
D1	7.50	N.		
Е	10		10.40	
E1	8.50			
е	C	2.54		
e1	4.88		5.28	
Ц	15		15.85	
J1	2.49		2.69	
L L	2.29		2.79	
L1	1.27		1.40	
L2	1.30		1.75	
R		0.4		
V2	0°		8°	

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L1 SEATING PLANE COPLANARITY Obsolete Productils GAUGE PLANE 0079457\_R

Figure 19. D<sup>2</sup>PAK (TO-263) drawing

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Revision history STGB10NC60K

# 5 Revision history

Table 9. Document revision history

	Date	Revision	Changes	
	21-Nov-2005	1	New release	
	06-Dic-2005	2	Inserted row on Table 2: Absolute maximum ratings	
	08-Feb-2007	3	Description has been updated	
	24-Feb-2011	4	Updated package mechanical data <i>Table 8. on page 8</i> and <i>Figure 19. on page 9</i>	
Obsole	ie Pro	ducil	Updated package mechanical data Table 8. on page 8 and Figure 19. on page 9	

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